



General Information	
Series	KPS SMD Comm X8L HT150C
Style	Stacked Chip
Description	SMD, MLCC, Stacked, Single Chip, High Temperature
Features	High Temperature
RoHS	Yes
Termination	Tin
AEC-Q200	No
Component Weight	160 mg
Chip Size	1210-1
Shelf Life	78 Weeks
MSL	1

Click here for the 3D model.

Dimensions	
L	3.5mm +/-0.3mm
W	2.6mm +/-0.3mm
т	3.35mm +/-0.10mm
В	0.8mm +/-0.15mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	600

Specifications	
Capacitance	2.2 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+150°C
Temperature Coefficient	X8L
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	+15% (-55C to +125C), +15/- 40% (125C to 150C), 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	227.3 MOhms

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